Integrated Device Technology, Inc.

20-BIT BUS SWITCH

IDT74FST163384
IDT74FST1632384
ADVANCE INFORMATION

FEATURES:

- Bus switches provide zero delay paths
- Extended commercial range of –40°C to +85°C
- Low switch on-resistance:
  FST163xxx – 5Ω
  FST1632xxx — 28Ω
- TTL-compatible input and output levels
- ESD > 2000V per MIL-STD-883, Method 3015;
  > 200V using machine model (C = 200pF, R = 0)
- Available in SSOP, TSSOP and TVSOP

DESCRIPTION:

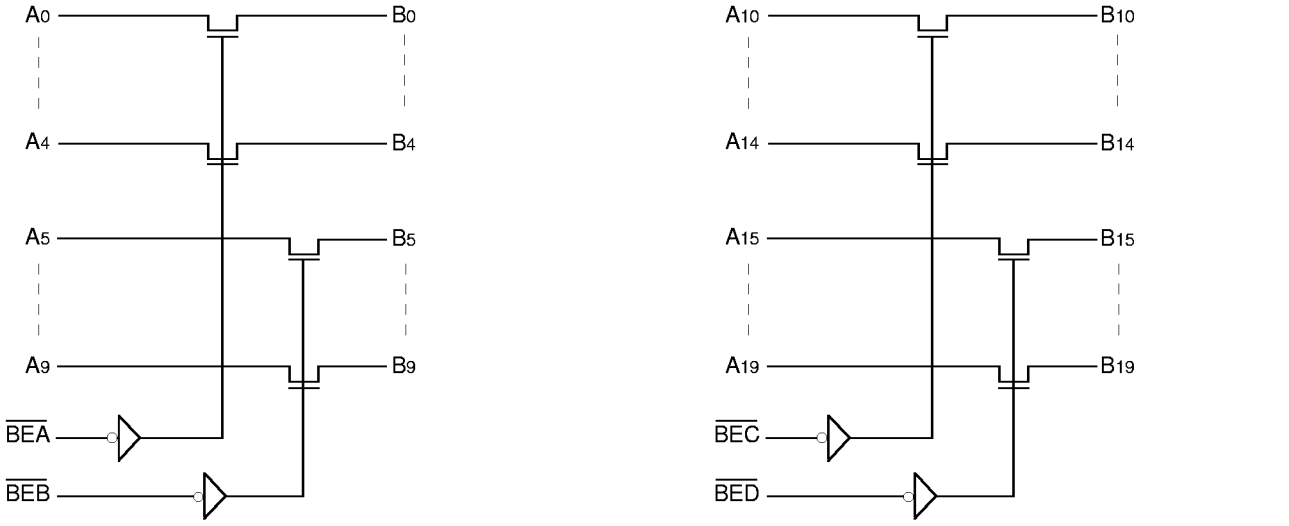
The FST163384/1632384 belong to IDT's family of Bus switches. Bus switch devices perform the function of connecting or isolating two ports without providing any inherent current sink or source capability. Thus they generate little or no noise of their own while providing a low resistance path for an external driver. These devices connect input and output ports through an n-channel FET. When the gate-to-source junction of this FET is adequately forward-biased the device conducts and the resistance between input and output ports is small. Without adequate bias on the gate-to-source junction of the FET, the FET is turned off, therefore with no V_{CC} applied, the device has hot insertion capability.

The low on-resistance and simplicity of the connection between input and output ports reduces the delay in this path to close to zero.

The FST1632xxx integrates terminating resistors in the device, thus eliminating the need for external 25Ω series resistors.

The FST163384 and FST1632384 are 20-bit TTL-compatible bus switches. The BEx pins provide enable control.

FUNCTIONAL BLOCK DIAGRAM



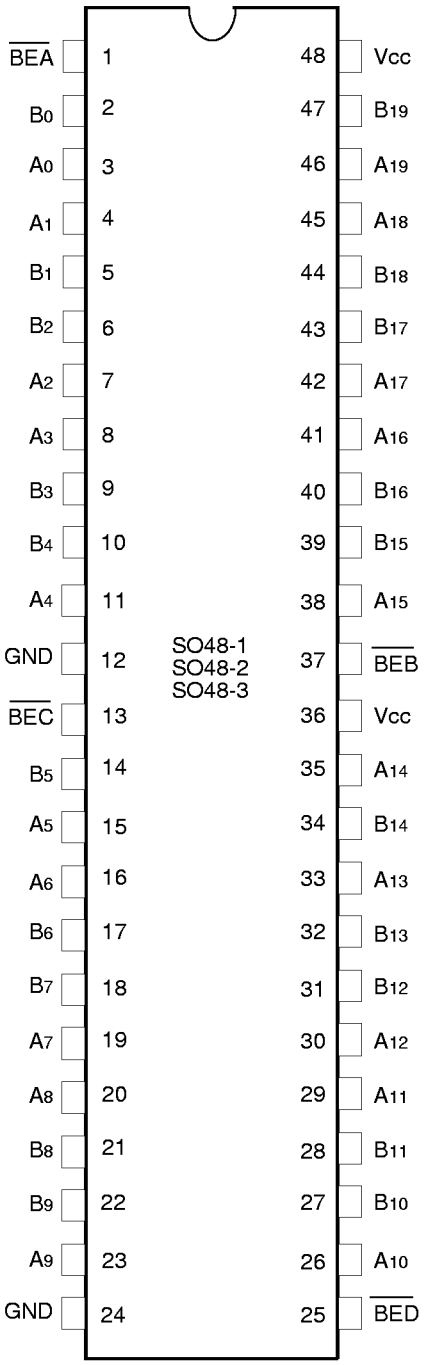
3473 drw 01

PIN DESCRIPTION

Pin Names	I/O	Description
$A_{0\text{-}19}$	I/O	Bus A
$B_{0\text{-}19}$	I/O	Bus B
$\overline{BEA}$, $\overline{BEB}$, $\overline{BEC}$, $\overline{BED}$,	I	Bus Switch Enable (Active LOW)

3473 tbl 01

PIN CONFIGURATION



SSOP/
TSSOP/TVSOP
TOP VIEW

3473 drw 02

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max.	Unit
V_{TERM}(2)	Terminal Voltage with Respect to GND	–0.5 to +7.0	V
T_{STG}	Storage Temperature	–65 to +150	°C
I_{OUT}	Maximum Continuous Channel Current	128	mA

3473 tbl 02

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating condiitions for extended periods may affect reliability.
2. V_{CC}, Control and Switch terminals.

FUNCTION TABLE

$\overline{BEA}$	$\overline{BEB}$	B_{0-4}	B_{5-9}	Description
H	H	Hi-Z	Hi-Z	Disconnect
L	H	A_{0-4}	Hi-Z	Connect
H	L	Hi-Z	A_{5-9}	Connect
L	L	A_{0-4}	A_{5-9}	Connect
$\overline{BEC}$	$\overline{BED}$	B_{10-14}	B_{15-19}	Description
H	H	Hi-Z	Hi-Z	Disconnect
L	H	A_{10-14}	Hi-Z	Connect
H	L	Hi-Z	A_{15-19}	Connect
L	L	A_{10-14}	A_{15-19}	Connect

3473 tbl 03

CAPACITANCE(1)

Symbol	Parameter	Conditions(2)	Typ.	Unit
C_{IN}	Control Input Capacitance		4	pF
$C_{I/O}$	Switch Input/Output Capacitance	Switch Off		pF

3473 tbl 04

NOTES:

1. Capacitance is characterized but not tested
2. T_A = 25°C, f = 1MHz, V_{IN} = 0V, V_{OUT} = 0V

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Commercial: T_A = –40°C to +85°C, V_{CC} = 5.0V ±10%

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH for Control Inputs		2.0	—	—	V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW for Control Inputs		—	—	0.8	V
I_{IH}	Input HIGH Current	V_{CC} = Max.	V_I = V_{CC}	—	—	±1	µA
I_{IL}	Input LOW Voltage		V_I = GND	—	—	±1	
I_{OZH}	High Impedance Output Current	V_{CC} = Max.	V_O = V_{CC}	—	—	±1	µA
I_{OZL}	(3-State Output pins)		V_O = GND	—	—	±1	
I_{OS}	Short Circuit Current	V_{CC} = Max., V_O = GND[3]		—	300	—	mA
V_{IK}	Clamp Diode Voltage	V_{CC} = Min., I_{IN} = –18mA		—	–0.7	–1.2	V
R_{ON}	Switch On Resistance[4]	V_{CC} = Min. V_{IN} = 0.0V	163xxx	—	5	7	Ω
		I_{ON} = 30mA	1632xxx	20	28	40	
		V_{CC} = Min. V_{IN} = 2.4V	163xxx	—	10	15	Ω
		I_{ON} = 15mA	1632xxx	20	35	48	
I_{OFF}	Input/Output Power Off Leakage	V_{CC} = 0V, V_{IN} or $V_O \leq$ 4.5V		—	—	1	µA
I_{CC}	Quiescent Power Supply Current	V_{CC} = Max., V_{IN} = GND or V_{CC}		—	0.1	3	µA

3473 tbl 05

NOTES:
1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
4. Measured by voltage drop between ports at indicated current through the switch.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Typ.[2]	Max.	Unit
ΔI_{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V_{CC} = Max. V_{IN} = 3.4V[3]		—	0.5	1.5	mA
I_{CCD}	Dynamic Power Supply Current[4]	V_{CC} = Max. Outputs Open Enable Pin Toggling 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND	—	30	40	µA/ MHz/ Switch
I_C	Total Power Supply Current[6]	V_{CC} = Max. Outputs Open Enable Pins Toggling (20 Switches Toggling) fi = 10MHz 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND	—	6.0	8.0	mA
			V_{IN} = 3.4 V_{IN} = GND	—	7.0	11.0	

NOTES:

3473 tbl 06

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V). All other inputs at V_{CC} or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
5. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
   $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_i N)$
   I_{CC} = Quiescent Current
   ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
   D_H = Duty Cycle for TTL Inputs High
   N_T = Number of TTL Inputs at D_H
   I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
   f_i = Input Frequency
   N = Number of Switches Toggling at fi
   All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Commercial: T_A =–40°C to +85°C, V_{CC} = 5.0V ±10%

Symbol	Description	Condition[1]	Min.[2]	Typ.	163384 Max.	1632384 Max.	Unit
t_{PLH} t_{PHL}	Data Propagation Delay Ai to Bi, Bi to Ai[3,4]	C_L = 50pF R_L = 500Ω	—	—	0.25	1.25	ns
t_{PZH} t_{PZL}	Switch Turn on Delay BEx to Ai, Bi		1.5	—	6.5	7.5	ns
t_{PHZ} t_{PLZ}	Switch Turn off Delay BEx to Ai, Bi[3]		1.5	—	5.5	5.5	ns
$\|Q_{CI}\|$	Charge Injection[5,6]		—	1.5	—	—	pC

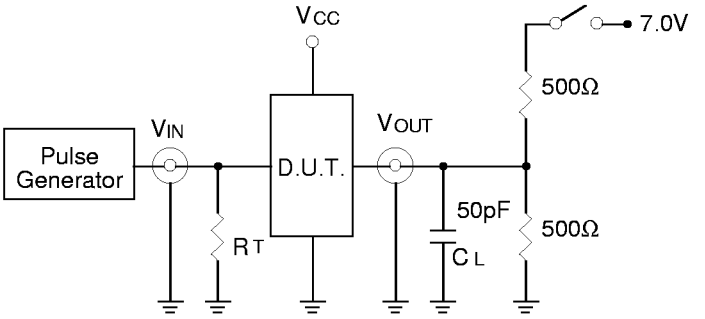
NOTES:

3473 tbl 07

1. See test circuit and waveforms.
2. Minimum limits guaranteed but not tested.
3. This parameter is guaranteed by design but not tested.
4. The bus switch contributes no propagation delay other than the RC delay of the on resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 2.5ns for 50pF load. Since this time is constant and much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay on the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
5. Measured at switch turn off, load = 50 pF in parallel with 10MΩ scope probe, V_{IN} = 0.0 volts.
6. Characterized parameter. Not 100% tested.

TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS



3473 lnk 03

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

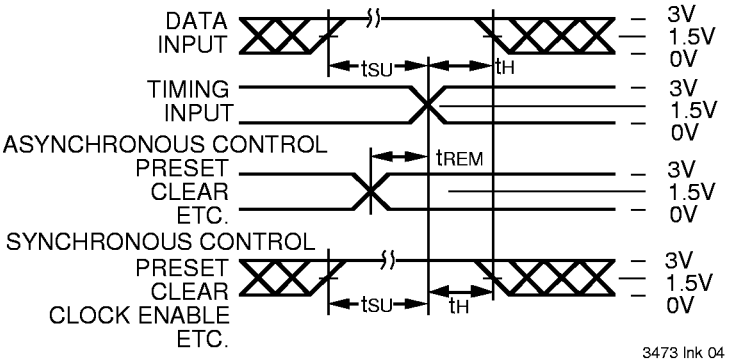
3473 lnk 08

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

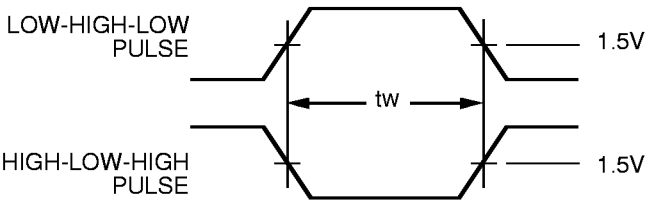
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

SET-UP, HOLD AND RELEASE TIMES



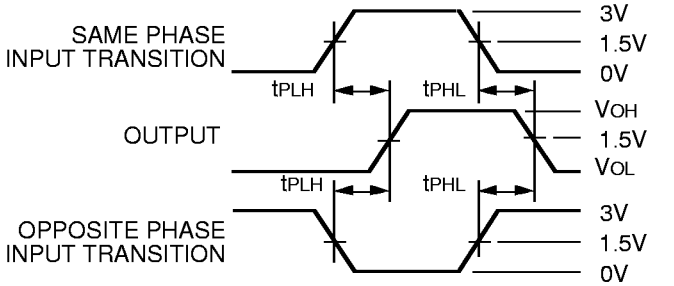
3473 lnk 04

PULSE WIDTH



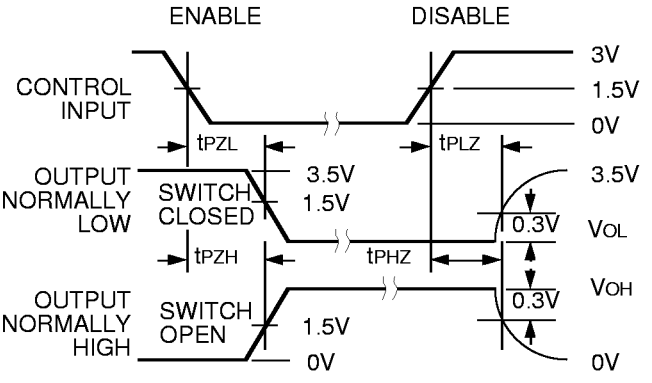
3473 lnk 05

PROPAGATION DELAY



3473 lnk 06

ENABLE AND DISABLE TIMES

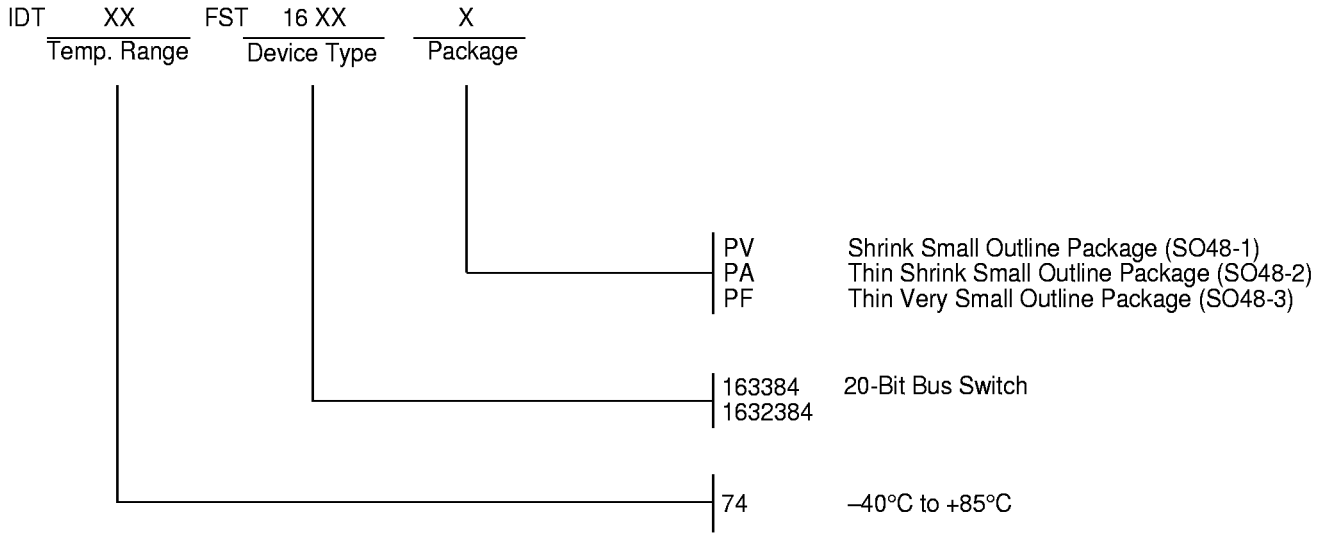


3473 lnk 07

NOTES:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH
2. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; $t_F \leq 2.5$ns; $t_R \leq 2.5$ns

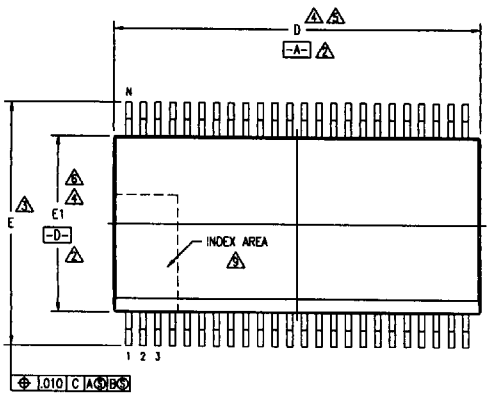
ORDERING INFORMATION

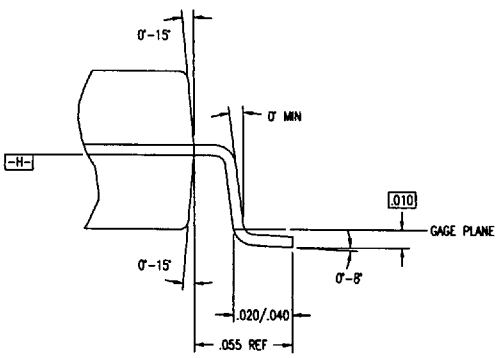


3473 drw 08

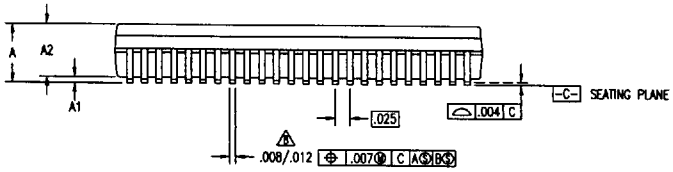
SSOP

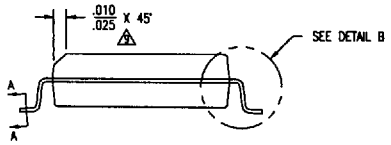
REVISIONS				
DCN	REV	DESCRIPTION	DATE	APPROVED
17893	00	INITIAL RELEASE	07/15/90	A. FUNCELL
22377	01	REMOVE CHAMFER FROM PACKAGE	04/15/92	T. VU
27492	02	REDRAW TO JEDEC FORMAT	02/01/95	

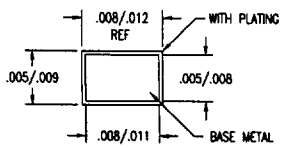




DETAIL B





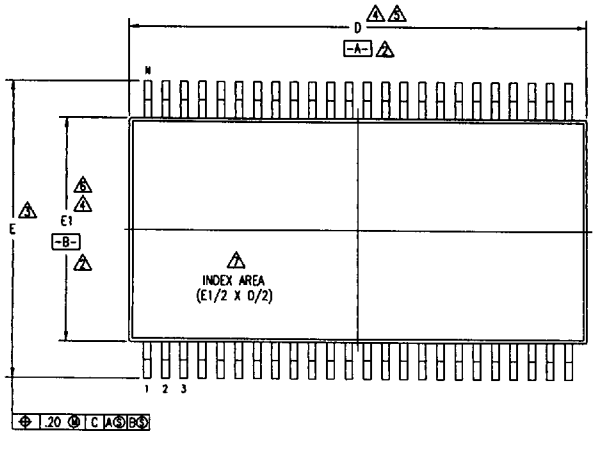


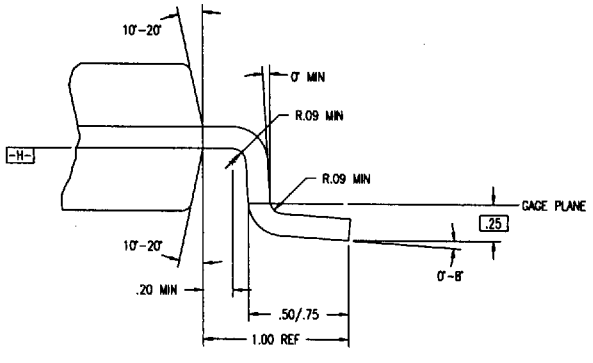
SECTION A-A

TOLERANCES UNLESS SPECIFIED		Integrated Device Technology, Inc. 2975 Stender Way, Santa Clara, CA 95054 PHONE: (408) 727-6116 FAX: (408) 492-8674 TWX: 910-338-2070	
DECIMAL XX± XXX± XXXX±	ANGULAR ±		
APPROVALS	DATE	TITLE PV PACKAGE OUTLINE .300" BODY WIDTH SSOP .025" PITCH	
DRAWN AA	08/15/90		
CHECKED		SIZE C	DRAWING No. PSC-4029 REV 02
		DO NOT SCALE DRAWING	

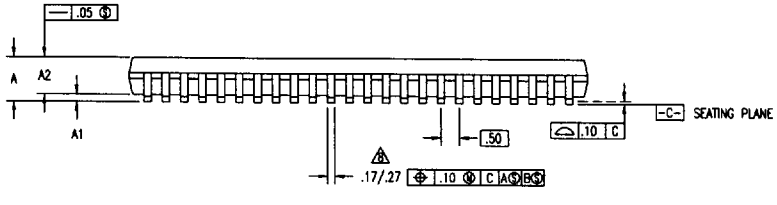
TSSOP

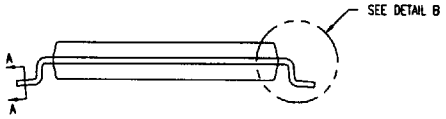
REVISIONS				
DCN	REV	DESCRIPTION	DATE	APPROVED
23757	00	INITIAL RELEASE	02/15/93	T. VU
26315	01	CHANGE DIMS A1 & A2	05/18/94	DG
25490	02	CHANGE DIM A1	07/21/94	T. VU
27494	03	REDRAW TO JEDEC FORMAT	03/08/95	

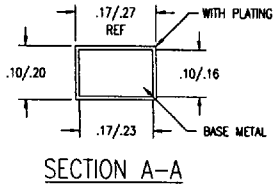




DETAIL B



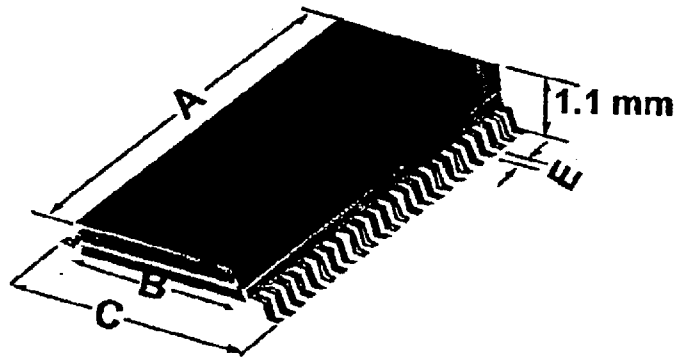




SECTION A-A

TOLERANCES UNLESS SPECIFIED		Integrated Device Technology, Inc. 2975 Stender Way, Santa Clara, CA 95054 PHONE: (408) 727-6116 FAX: (408) 492-8674 TWX: 910-338-2070	
DECIMAL	ANGULAR		
XX±	±		
XXX±			
XXXX±			
APPROVALS	DATE	TITLE	PA PACKAGE OUTLINE 6.10 mm BODY WIDTH TSSOP .50 mm PITCH
DRAWN dd	01/15/93		
CHECKED		SIZE C	DRAWING No. PSC-4039 REV 03
		DO NOT SCALE DRAWING	

TVSOP
The Most Compact Double Density Package



TVSOP Package	Typical Dimensions (in mm)				Area (mm2)
	A	B	C	E	
48 Pin	9.80	4.40	6.40	0.40	63.00
56 Pin	11.30	4.40	6.40	0.40	72.30
80 Pin	17.00	6.10	8.10	0.40	137.80
100 Pin	20.80	6.10	8.10	0.40	168.50